



# High End Digital Processing Technologies and EEE Components for Future Space Missions

## Monday, 1 October 2018

Technology Suppliers Perspective: Teledyne E2V : High end microprocessors with space reliability- Frederic Devriere - Newton 1 (14:00 - 14:10)

Technology Suppliers Perspective: Xilinx - Steven Hofmans - Newton 1 (14:10 - 14:20)

Technology Suppliers Perspective: 3DPlus : Pierre-Eric Berthet - Newton 1 (14:20 - 14:30)

Technology Suppliers Perspective: Texas instruments Enabling New Space: Amit Goyal - Newton 1 (14:30 - 14:40)

Technology Suppliers Perspective: Intersil/ Renesas : Oscar Mansilla & Steve Singer - Newton 1 (14:40 - 14:50)

Technology Suppliers Perspective: Cobham Gaisler Enabling Technologies : Lars Wallhede - Newton 1 (14:50 - 15:00)

Technology Suppliers Perspective: Microsemi: Eric Van Der Heijden - Newton 1 (15:00 - 15:10)

Technology Suppliers Perspective: Microchip-ATMEL - Newton 1 (15:10 - 15:20)

Technology Suppliers Perspective: NanoXplore answer to HEDTP : Joel Le Mauff - Newton 1 (15:20 - 15:30)

Technology Suppliers Perspective: GlobalFoundries : Jens Drews - Newton 1 (15:30 - 15:40)

Technology Suppliers Perspective: NVIDIA: Alison Lowndes - Newton 1 (15:40 - 15:50)

Technology Suppliers Perspective: STM : Thibault Brunet - Newton 1 (15:50 - 16:00)

Technology Suppliers Perspective: Picosun ALD Process : Marko Pudas - Newton 1 (16:00 - 16:10)